

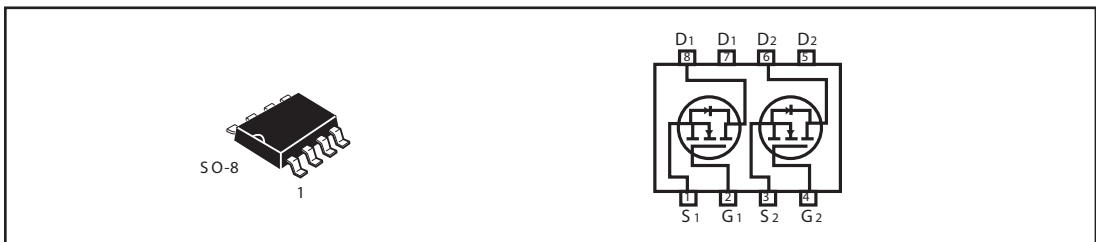


## Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V <sub>DSS</sub>	I <sub>D</sub>	R <sub>DS(ON)</sub> (mΩ) Max
55V	4.8A	45 @ V <sub>GS</sub> = 10V 65 @ V <sub>GS</sub> = 4.5V

### FEATURES

- Super high dense cell design for low R<sub>DS(ON)</sub>.
- Rugged and reliable.
- Surface Mount Package.



### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage Rating	V <sub>spike</sub> <sup>d</sup>	60	V	
Drain-Source Voltage	V <sub>DS</sub>	55	V	
Gate-Source Voltage	V <sub>GS</sub>	±25	V	
Drain Current-Continuous <sup>a</sup> @ T <sub>a</sub>	I <sub>D</sub>	25°C	4.8	A
		70°C	4.1	A
-Pulsed <sup>b</sup>	I <sub>DM</sub>	30	A	
Drain-Source Diode Forward Current <sup>a</sup>	I <sub>S</sub>	1.7	A	
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	T <sub>a</sub> =25°C	2	W
		T <sub>a</sub> =70°C	1.44	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient <sup>a</sup>	R <sub>θJA</sub>	62.5	°C/W
--	------------------	------	------

# STM6930

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> 25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA	55			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 44V, V <sub>GS</sub> = 0V			1	uA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ±25V, V <sub>DS</sub> = 0V			±100	nA
<b>ON CHARACTERISTICS<sup>b</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250uA	1.0	1.9	2.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 4.5A		35	45	m ohm
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4A		55	65	m ohm
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> = 5V, V <sub>GS</sub> = 10V	20			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 4.5A		9		S
<b>DYNAMIC CHARACTERISTICS<sup>c</sup></b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V f = 1.0MHz		900	1170	pF
Output Capacitance	C <sub>OSS</sub>			80	104	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			60	78	pF
Gate resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1.0MHz		2		ohm
<b>SWITCHING CHARACTERISTICS<sup>c</sup></b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> = 30V I <sub>D</sub> = 4.8 A V <sub>GS</sub> = 10V R <sub>GEN</sub> = 6 ohm		19	25	ns
Rise Time	t <sub>r</sub>			5	7	ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			22	29	ns
Fall Time	t <sub>f</sub>			12	16	ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 48V, I <sub>D</sub> = 4.8A, V <sub>GS</sub> = 10V		19	25	nC
		V <sub>DS</sub> = 48V, I <sub>D</sub> = 4.8A, V <sub>GS</sub> = 4.5V		9	12	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 48V, I <sub>D</sub> = 4.8 A		4	5	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> = 10V		4.5	6	nC

# STM6930

## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
<b>DRAIN-SOURCE DIODE CHARACTERISTICS<sup>b</sup></b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_s = 1.7A$		0.8	1.2	V

### Notes

a. Surface Mounted on FR4 Board,  $t \leq 10\text{sec}$ .

b. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

c. Guaranteed by design, not subject to production testing.

d. Guaranteed when external  $R_g = 6\ \text{ohm}$  and  $t_f < t_{f\text{max}}$

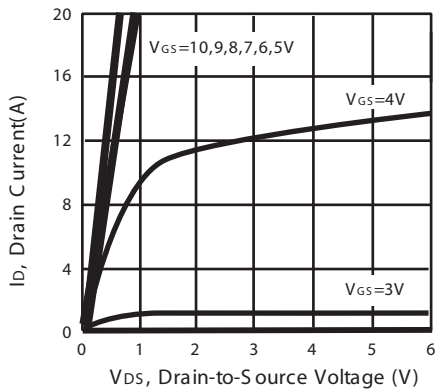


Figure 1. Output Characteristics

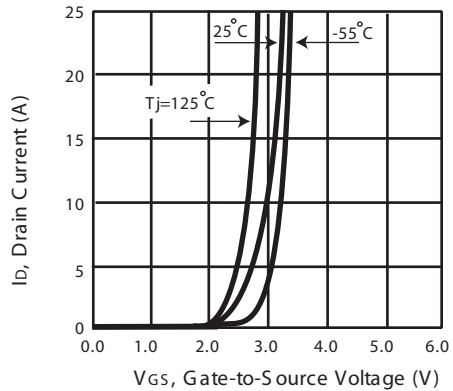


Figure 2. Transfer Characteristics

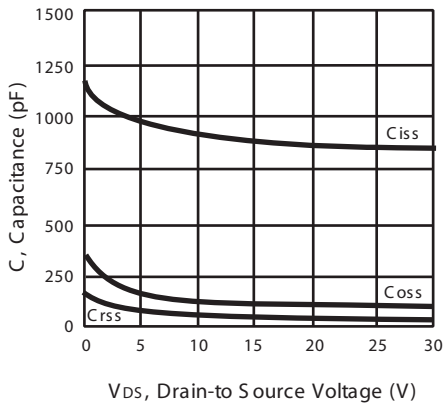


Figure 3. Capacitance

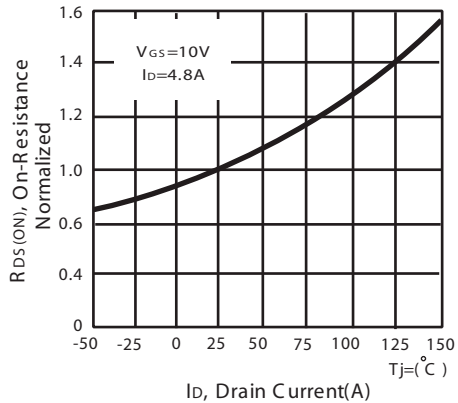


Figure 4. On-Resistance Variation with Drain Current and Temperature

# STM6930

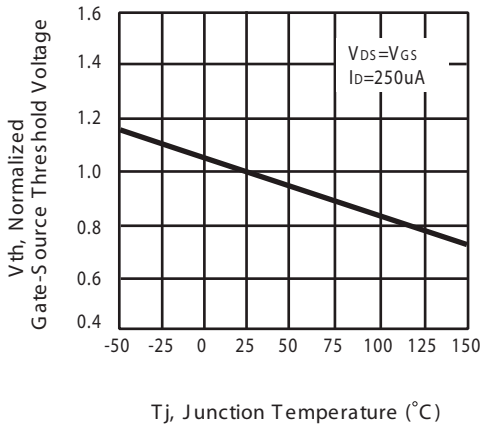


Figure 5. Gate Threshold Variation with Temperature

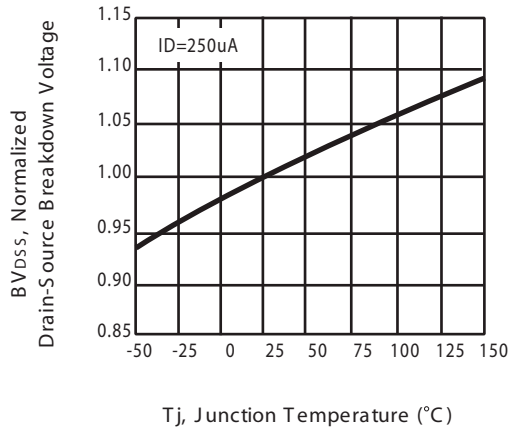


Figure 6. Breakdown Voltage Variation with Temperature

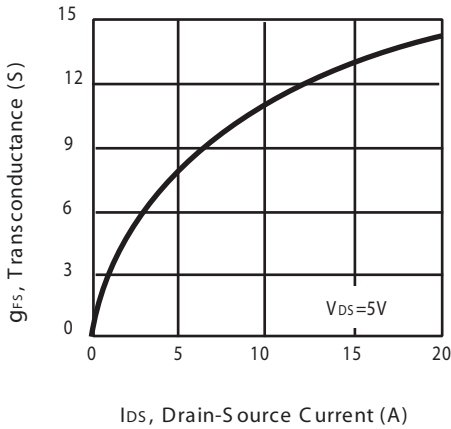


Figure 7. Transconductance Variation with Drain Current

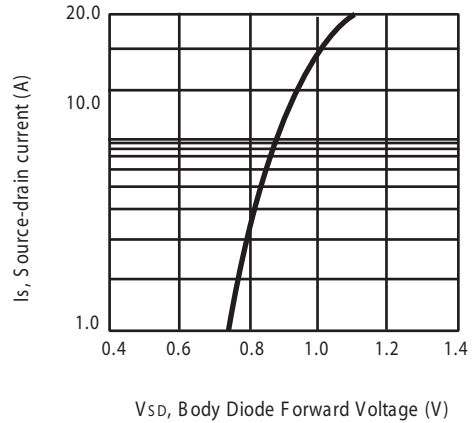


Figure 8. Body Diode Forward Voltage Variation with Source Current

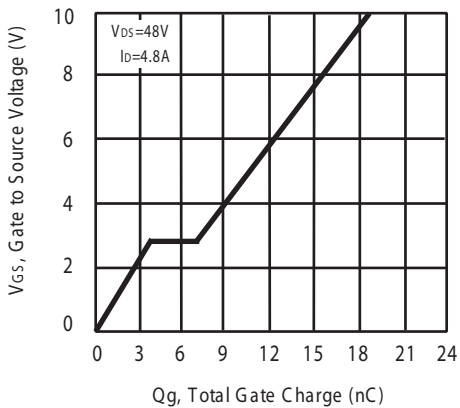


Figure 9. Gate Charge

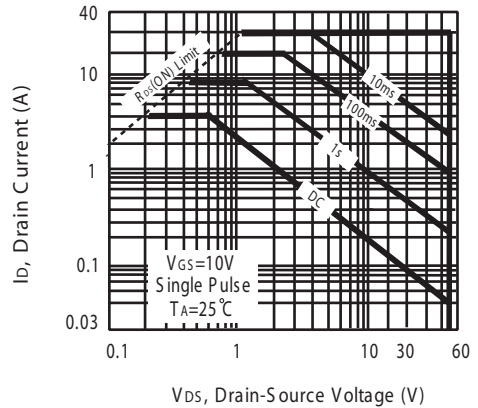


Figure 10. Maximum Safe Operating Area

# STM6930

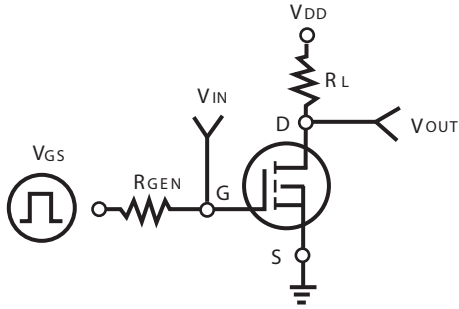


Figure 11. Switching Test Circuit

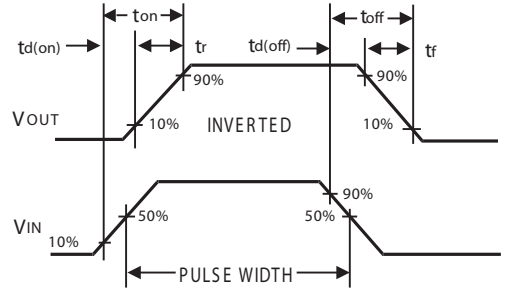
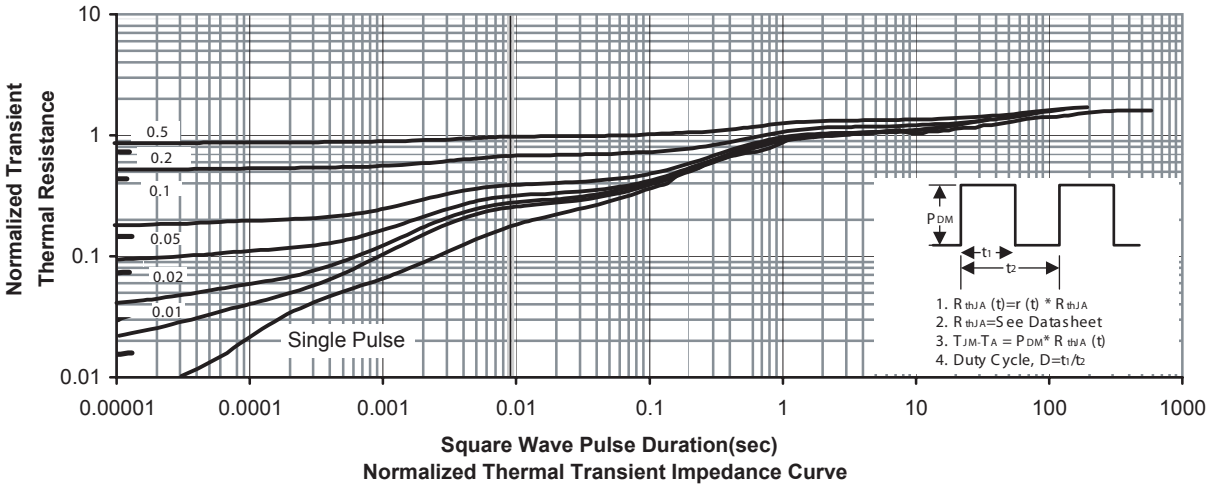


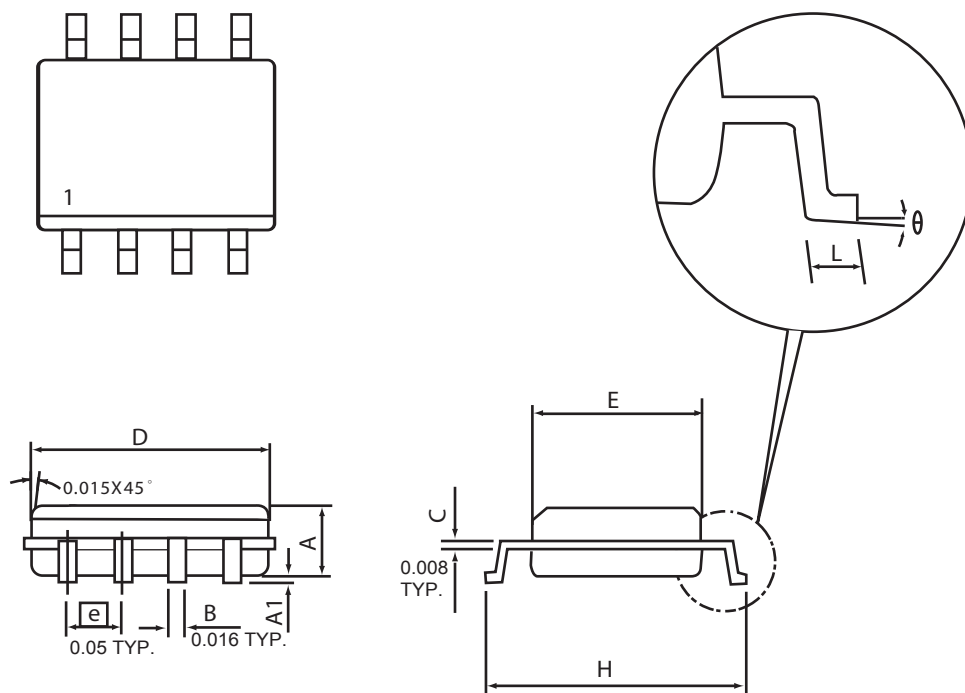
Figure 12. Switching Waveforms



# STM6930

## PACKAGE OUTLINE DIMENSIONS

SO-8

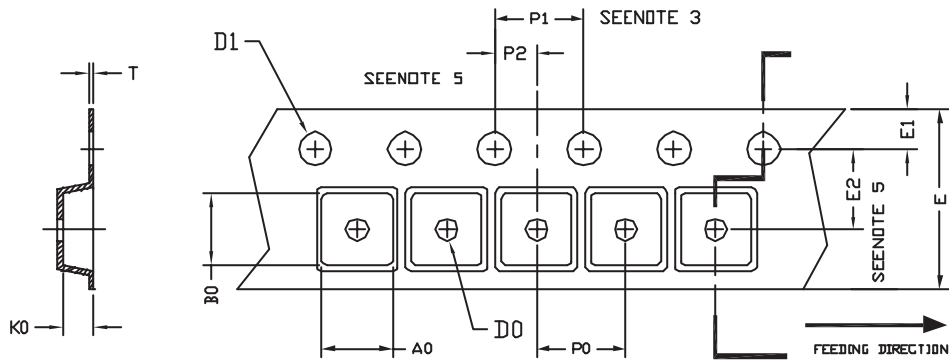


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	4.98	0.189	0.196
E	3.81	3.99	0.150	0.157
H	5.79	6.20	0.228	0.244
L	0.41	1.27	0.016	0.050
$\theta$	0°	8°	0°	8°

# STM6930

## SO-8 Tape and Reel Data

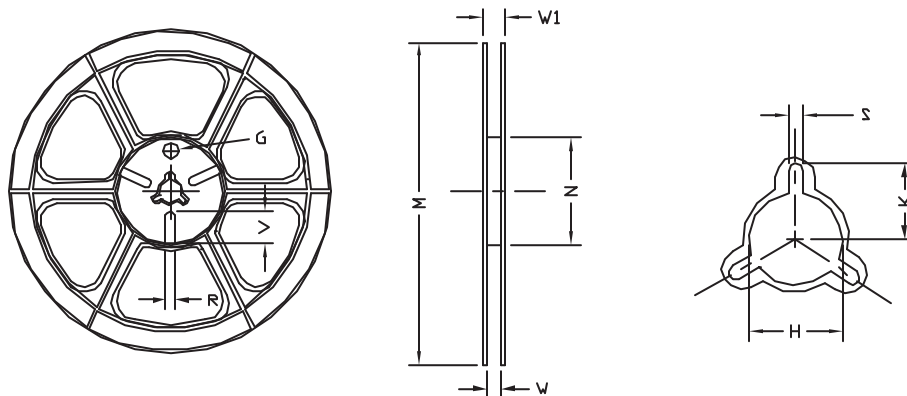
### SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.40	5.20	2.10	$\phi$ 1.5 (MIN)	$\phi$ 1.5 + 0.1 - 0.0	12.0 $\pm$ 0.3	1.75	5.5 $\pm$ 0.05	8.0	4.0	2.0 $\pm$ 0.05	0.3 $\pm$ 0.05

### SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi$ 330	330 $\pm$ 1	62 $\pm$ 1.5	12.4 + 0.2	16.8 - 0.4	$\phi$ 12.75 + 0.15	---	2.0 $\pm$ 0.15	---	---	---